## International Journal of Microwave and Wireless Technologies

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## **Research Paper**

**Cite this article:** Xuan X, Cheng Z, Hayes B, Zhang Z, Gong T, Wu S, Le C (2024) An ultra-wideband power amplifier designed through a bandwidth expansion strategy. *International Journal of Microwave and Wireless Technologies* **16**(7), 1138–1143. https://doi.org/10.1017/S1759078724000552

Received: 17 December 2023 Revised: 19 April 2024 Accepted: 29 April 2024

#### **Keywords:**

bandwidth expansion strategy; impedance conversion ratio; parallel impedance matching architecture; power amplifiers (PAs); ultra-wideband

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# An ultra-wideband power amplifier designed through a bandwidth expansion strategy

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## Abstract

A bandwidth expansion strategy for ultra-wideband power amplifiers (PAs) is presented in this letter by adopting a parallel impedance matching architecture. This design strategy can effectively reduce the impedance conversion ratio between the load and the target impedance of the PA, thereby providing a feasible solution for broadband impedance matching. Subsequently, a commercially available 10 W gallium nitride device and a two-stage Wilkinson power divider network are combined to achieve the verification of the proposed theory. The results of the measurement show that within the target frequency band of 0.9–3.9 GHz, 58.5–71.2% of the drain efficiency and 9.1–12 dB of gain can be achieved with a saturated output power of 39.1–42 dBm.

## Introduction

The next generation of wireless communication systems is required to operate on different frequency bands for different applications. Taking mobile communication as an example, the arrival of the fifth generation (5G) communication era has led to an increasing number of high-frequency bands being included in the communication frequency band. Therefore, as a core component of the communication system, power amplifiers (PAs) are required to operate efficiently over a wide frequency band [1–5].

The continuous mode [6-8], developed based on harmonic-tuning technology, is considered one of the most promising bandwidth expansion technologies at present. However, considering that relying solely on expanding the target impedance space is difficult to satisfy the practical application requirements in the context of ultra-wideband operation required by 5G communication, improving the impedance matching network has become an effective way to expand the operating bandwidth of PAs, such as simplifying real-frequency technology [9, 10] and distributed matching networks [11, 12], which have been proven to have outstanding performance in broadband impedance matching. Among them, simplified real frequency technology is to find a suitable impedance matching path through algorithm optimization to complete the matching between load and target impedance of PA in a wide frequency band, as shown in papers [9, 10]. Distributed filtering matching networks are usually based on low-pass or band-pass filtering networks, which are synthesized or improved into impedance matching networks with broadband responses to achieve bandwidth expansion of PAs, such as papers [11, 12]. However, it can be found that neither optimization algorithms represented by simplified real frequency nor distributed filtering networks can be directly used for matching network design, and it is necessary to first convert the lumped parameters into distributed parameters. The conversion of lumped components to transmission lines will introduce errors, and further optimization is needed to reduce the errors caused by the conversion. As a result, the design complexity of PAs will be increased.

In this letter, a bandwidth expansion design strategy is proposed to achieve the design of an ultra-wideband PA operating at 0.9–3.9 GHz by using a parallel impedance matching architecture. The measured results indicate that within the target frequency band, 58.5–71.2% of the drain efficiency (DE), 39.1–42 dBm of output power, and 9.1–12 dBm of gain are achieved.

## **Design theory**

The difficulty of bandwidth expansion in ultra-wideband PAs depends on the conversion ratio between the load and the target impedance. Generally speaking, the larger the difference between the load and target impedance, the more difficult it will be to maintain good impedance matching within wideband. Therefore, the key to implementing ultrawideband PAs lies in designing impedance matching networks to reduce the conversion ratio from load to target impedance. Based on this design concept, a novel parallel impedance

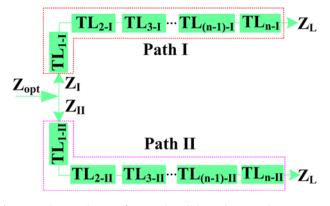


Figure 1. Schematic diagram of proposed parallel impedance matching architecture.

matching architecture is proposed to reduce the load to target impedance conversion ratio, as shown in Fig. 1. The presented parallel impedance matching architecture consists of two matching paths, each of which is composed of an undetermined number of series transmission lines, used to achieve the matching of load impedance  $Z_{\rm L}$  to impedance  $Z_{\rm I}$  and  $Z_{\rm II}$  by employing the principle of transmission line impedance transformation [13].

As a result, the input impedance  $Z_{\rm opt}$  can be calculated as follows:

$$Z_{\text{opt}} = \left(Z_1 \bullet Z_{\text{II}}\right) / \left(Z_1 + Z_{\text{II}}\right) \tag{1}$$

Assuming  $Z_{I}$  and  $Z_{II}$  are considered pure resistors, equation (1) can be transformed as follows:

$$Z_{\text{opt}} = (Z_{1\bullet} Z_{\text{II}}) / (Z_1 + Z_{\text{II}}) \le (Z_1 + Z_{\text{II}}) / 4$$
(2)

Therefore, it can be observed that the impedance achieved through two parallel impedance matching architectures is always less than or equal to a quarter of the sum of the impedances matched in paths I and II, respectively. Only under the condition of  $Z_{\rm I} = Z_{\rm II}$ , can equality be obtained, which means that even if the input impedance  $Z_{\rm opt}$  is taken as the maximum, it is only half of  $Z_{\rm I}$  or  $Z_{\rm II}$ . As a result, under this condition, the impedance conversion required for the proposed parallel impedance matching architecture is directly reduced by 50% compared to conventional impedance matching networks, which is extremely advantageous for achieving ultra-wideband impedance matching.

## **Realization of ultra-wideband PA**

In this section, based on the proposed parallel impedance matching architecture, an ultra-wideband PA operating at 0.9–3.9 GHz is designed using a commercially available 10 W gallium nitride (GaN) device provided by Cree, and the gate and drain bias voltages are set at -2.7 V and 28 V, respectively.

## Acquisition of optimal impedance

The design of ultra-wideband PAs starts with achieving the target impedance within the design frequency band. Based on the current application requirements of wireless communication systems, PAs are required to work efficiently on a wide frequency band, so obtaining the target impedance is particularly important. In terms of efficiency improvement, considering the presence of harmonics, especially second harmonics, is crucial. In PA design,

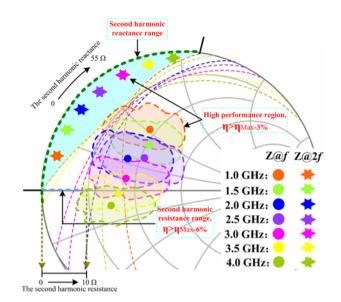


Figure 2. Optimal impedances distribution for load in 1.0-4.0 GHz.

using load-pull technology to achieve the target impedance at the design frequency point is a common technical means, while the analysis of the second harmonic impedance is ignored, which leads to the inability to further ensure the efficiency of PA while completing bandwidth expansion. In view of this situation, to incorporate the second harmonic into the analysis of the target impedance, the multi-harmonic bilateral pull technique [14] is employed to achieve the fundamental and second harmonic impedances, providing design goals for the implementation of ultra-wideband PAs.

Then, based on the commercially available transistor model CGH40010F, the multi-harmonic bilateral pull technology is implemented at the device output for 1.0-4.0 GHz. As a result, the optimal fundamental and second harmonic impedance regions from the target frequency band are obtained, as shown in Fig. 2, where the internal regions of the fundamental and second harmonic impedance curves represent the tolerable regions for achieving high efficiency. In addition, more importantly, it can be observed from Fig. 2 that the second harmonic impedance region of the entire target frequency band is not limited to pure reactance but is extended to resistance-reactance under acceptable operating efficiency performance. Specifically, the imaginary part reactance varies between 0 and 55  $\Omega$ , while the real part resistance is extended between 0 and 10  $\Omega$ , which is consistent with the conclusion of the extended continuous mode [7] or inverse mode [15]. Based on this, it can be inferred that by selecting the target impedance region reasonably, the overlap between the second harmonic impedance and the fundamental impedance is allowed, indicating that maintaining good efficiency performance while completing bandwidth expansion can be achieved. So far, the target impedance of the design frequency band has been determined, and the next step is to complete the design of the ultra-wideband PA based on the parallel impedance matching architecture proposed in section "Design theory."

#### Design of ultra-wideband PA

Based on the target impedance obtained by combining the proposed parallel impedance matching architecture, the design of the ultra-wideband PA can be implemented. However, there are

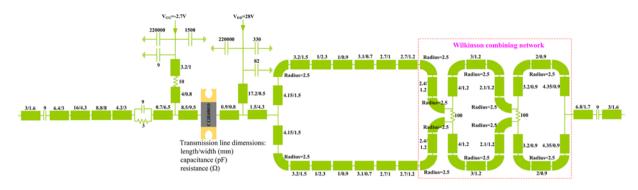


Figure 3. Schematic of the designed PA. Dimensions are in mm.

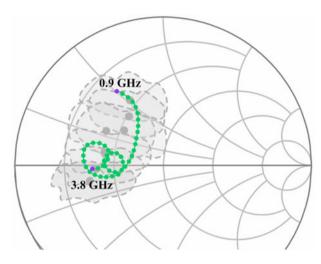


Figure 4. Impedance trajectory completed by output matching network.



Figure 5. Fabricated PA circuit.

two issues that need further discussion before this. Firstly, according to the proposed parallel impedance matching architecture, how to maintain the terminal impedance of two matching paths as the load impedance within the target frequency band. Considering the need to maintain good isolation between parallel impedance matching architectures and the ability of two signals to overlap in the same direction at the synthesis point, the Wilkinson combining network is chosen for use [13]. As long as a good input reflection coefficient is maintained at the input terminal of the Wilkinson power divider network, the terminal impedance of the matching path can be well maintained as  $Z_L$ . Here, the microwave system impedance is used as a reference, which is 50  $\Omega$ . Specifically, in order to further expand the operating bandwidth of the Wilkinson power divider network, a two-stage cascaded architecture is chosen [13].

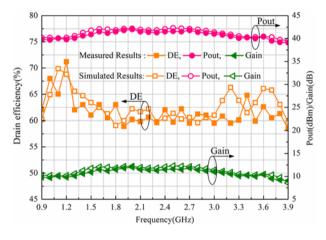


Figure 6. Measured and simulated DE, output power, and gain (at saturation) vs. frequency.

Secondly, how to consider the topology selection of two matching paths. In the theoretical analysis in section "Design theory," we pointed out that even if the input impedance of the two paths is set to be the same, as in the most general case, compared with traditional impedance matching networks, the proposed parallel impedance matching structure can still reduce the impedance conversion ratio by 50%. Therefore, the scheme of using the same impedance matching network for two matching paths is considered. In this way, the design complexity of the entire circuit will also be greatly reduced. As a result, the topology structure of the designed ultra-wideband PA is shown in Fig. 3.

Figure 4 shows the impedance trajectory completed by the output matching network. It can be observed from the figure that the completed impedance gradually moves toward the lower part of the Smith Circle with increasing frequency starting from 0.9 GHz, which is consistent with the trend of the target impedance varying with frequency. And it is basically located in the target impedance region, indicating the rationality of the impedance matching network design.

## Fabrication and measurement of PA

The photograph of the fabricated ultra-wideband PA is demonstrated in Fig. 5 on a Rogers 4350B substrate.

To further verify the frequency response of the designed ultrawideband PA, measurement of the PA is performed using continuous waveform signals from 0.9 to 3.9 GHz. Based on this, the

Table 1. Comparisons with state-of-the-art broadband PAs

Ref	Technology	BW (GHz)	RBW (%)	DE (%)	Power (dBm)	Gain (dB)	Static operating points	Type of transis- tor	Year
[16]	SCMs	1.6-2.8	54.5	67.5-81.9	39.08-42.5	NA	Vg = −3 V, Vd = 28 V	GaN	2014
[17]	SCMs	0.8–3.2	120	57-74	39.7-42.9	10.7-14.1	Vg = -3 V, $Vd = 28 V$	GaN	2018
[18]	Chebyshev low-pass network	1.9–3.1	48	48–56.6	39.3-40.5	9.3–10.7	Vg = -3 V, $Vd = 28 V$	GaN	2020
[19]	Particle swarm opti- mization	2.2-4.6	62.8	51-70	40-42.8	12.8–14.9	l <i>ds</i> = 150 mA, <i>V</i> d = 28 V	GaN	2021
[20]	Fictitious matching	0.5–3	143	53.4-70	39.6-41.4	10.6-12.4	Vg = -2.82 V, $Vd = 28 V$	GaN	2022
[21]	Harmonic- controlled matching network	2.9–3.3	12.9	68.2-74.3	36–38.6	NA	I <i>ds</i> = 60 mA, <i>V</i> d = 28 V	GaN	2023
This work	Parallel impedance matching architecture	0.9–3.9	125	58.5-71.2	39.1-42	9.1-12	Vg = −2.7 V, Vd = 28 V	GaN	2024

BW = bandwidth; RBW = relative bandwidth; SCMs = series of continuous modes.

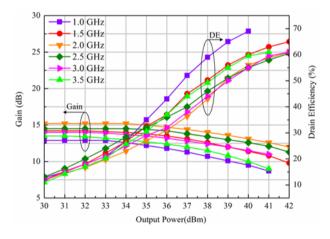


Figure 7. Measured DE and gain vs. output power for some in-band frequencies.

DE, output power, and gain achieved through measurement and simulation are plotted in Fig. 6. It can be seen that within the target frequency band of 0.9–3.9 GHz, the DE of 58.5–71.2% and the gain of 9.1–12 dB can be achieved under a saturation output power of 39.1–42 dBm. Table 1 shows that the proposed PA has a larger bandwidth compared to previously published work, fully utilizing the 10 W capability of the device.

To measure the dynamic characteristics of the implemented PA, the tested gain and DE vs. output power at six frequency points within the design frequency band are presented in Fig. 7. From the graph, it can be observed that the gain decreases with the increase in output power, while the DE shows an increase, meaning that a compromise between gain and efficiency needs to be considered in the design of PAs.

Furthermore, when the output power reaches saturation, increasing the output power further slows down the increase in DE significantly while the decrease in gain becomes more pronounced. Therefore, when saturated output is used as available power within the target frequency band, both gain and DE are at an acceptable level.

## Conclusion

An ultra-wideband PA has been designed and characterized by using a bandwidth expansion strategy that utilizes a parallel impedance matching architecture. This strategy can effectively reduce the impedance conversion ratio between the load and the target impedance, thereby achieving the goal of bandwidth expansion. The designed PA was fabricated and measured, and the test results showed that with an output power of 39.1–42 dBm, the DE of 58.5–71.2% and the gain of 9.1–12 dB can be achieved within the target frequency band of 0.9–3.9 GHz, demonstrating the feasibility of the design theory.

**Data availability statement.** The data that support the findings of this study are openly available in International Journal of Microwave and Wireless Technologies.

Acknowledgements. The work proposed by National Key R&D Program of China (Grant 2018YFE0207500), Project of Ministry of Science and Technology (Grant D20011), the National Natural Science Foundation (Grant 62201181), the University Natural Science Foundation of Anhui Province (Grant 2022AH051578), the University Natural Science Foundation of Anhui Province (Grant 2023AH051543), Anhui Province Key Laboratory of Simulation and Design for Electronic Information System (Grant 2023ZDSYS09), Guiding Science and Technology Plan Project in Huainan City (Grant 4317).

**Competing interests.** We declare that the authors have no competing interests as defined by International Journal of Microwave and Wireless Technologies or other interests that might be perceived to influence the results and/or discussion reported in this paper. The authors report no conflict of interest.

Author contributions. Xuefei Xuan wrote the main manuscript text and derived the theory with Zhiqun Cheng, Zhiwei Zhang and Tingwei Gong performed the simulations. Brendan Hayes is responsible for the grammar

correction of the manuscript. Shenbing Wu prepared Figs. 5–7. Chao Le prepared Figs. 1–4 and Table 1. All authors contributed equally to analyzing data and reaching conclusions, and in writing the paper.

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